# **Specifications**

Products Name	Low Resistance Chip Resistor	
Product Series	FLRV6432WCR***F	
Classification	Generic specification	



## FLRV6432W Low Resistance Chip Resistor Specification

### 1. Application

This specification is applicable to FLRV6432W series for low resistance chip resistors.

(6)

2. Part numbering system

#### FLR V6432 W <u>C</u> R\*\*\* <u>F</u>

(1) (3) (4) (5) (2)

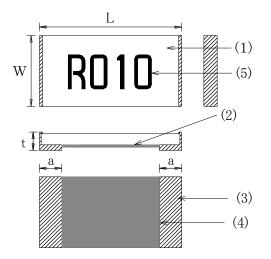
- (1) Product series
- (2) Size
- (3) Side-electrode type
- (4) Characteristic type
- (5) Nominal Resistance
- (6) Resistance tolerance

Foil Low Resistance Short-side electrode 6.4\*3.2mm size Wrap around High operating temperature type (example)  $100m\Omega \rightarrow R100$ F (±1.0%) G(±2.0%) J(±5.0%)

#### 3. Structure

Ceramic substrate is adhered to metal foil resistive element. Terminals are formed on top of the foil.

#### 4. Dimensions



- : Alumina (1) Substrate
- (2) Resistive element : Ni-Cu alloy
- (3) Terminal : Plated Ni/Sn over Cu
- (4) Protective coating : Epoxy (green) : Epoxy (black)

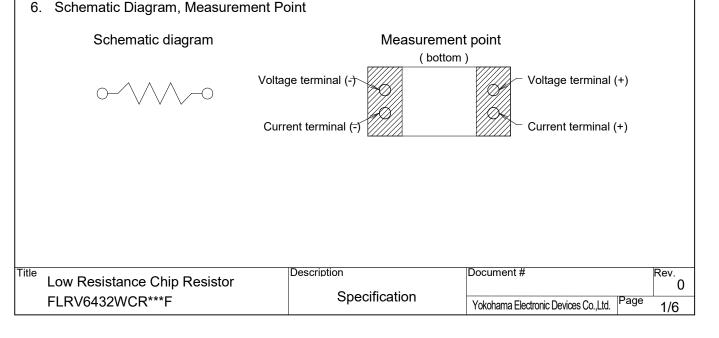
(5) Marking

Symbol	Dimensions (mm)		
	~4m ohm	5∼8m ohm	9m ohm∼
L	6.3±0.2	6.3±0.2	6.3±0.2
W	3.1±0.2	3.1±0.2	3.1±0.2
а	2.5±0.2	1.9±0.2	1.0±0.2
t	0.5±0.2	0.5±0.2	0.5±0.2

#### 5. Marking

Resistance value code is marked on the top surface.

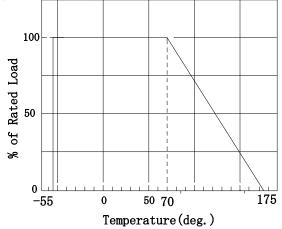
#### Example) $100m\Omega \rightarrow R100$



# 7. Specification

Specification		
Parameter	Specification	
Resistance Value	3 to $680m\Omega$ (possible state of Value)	
Resistance Tolerance	±1.0% (F), ±2.0% (G), ±5.0% (J)	
Temperature Coefficient of Resistance	±50ppm/°C	
Power Rating	3W (Derating Curve ··· Figure-1)	
Maximum Over Current	Which smaller between: $I = \sqrt{(36/R)}$ [A] Power: 36(W) R: Resistance( $\Omega$ ) I=70A (10m sec. max.) Interval 60 sec. Minimum. 10times.	
Operating Temperature Range	-55 ~ +175°C	
Rated Ambient Temperature	+70°C	

Figure-1 Derating curve



# 8. Performance

Test Item	Test Conditions		Specification
Short Time Over Load	Voltage of 1.5 times the rated power shall be applied for 5s.		±1.0%
Load life	Rated power on for 90 min, off for 30 min at 70±3°C for 1000h.		±1.0%
Moisture Load life	Rated power for 90 min, off for 30 min at 60±2°C, relative humidity of 90% for 1000h.		±2.0%
Temperature	[-55°C 30 min $\rightarrow$ R.T. 3min $\rightarrow$ +155°C 30	±1.0%	±1.0%
Cycle	$\min \rightarrow R.T. 3min]$	±2.0%	±2.0%
Resistance to soldering heat	260±5°C solder, 10±1sec dip		±0.5%
Board Bending	Test board length: 90mm Bend depth: 2mm Test board: Glass-Epoxy t=1.6mm		±1.0%
Solderability	245±5°C solder, 3+1/-0 sec dip.		90% terminal surface coverage by fresh solder

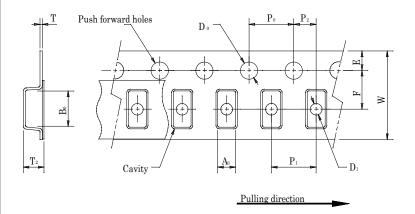
#### 9. Packaging

Packing quantity	5,000 pieces	/reel
Taping form	-	Figure-2
Peeling strength of seal tape		Figure-3
Reel form		Figure-4
Taping direction		Figure-5

Label contents: The following items shall be printed on the reel label. (Figure-6)

Part number
Quantity for each reel
Manufacturing month code
Manufacturer
Inspection number (Lot number)
The country of origin
Double dashed line which shows lead free

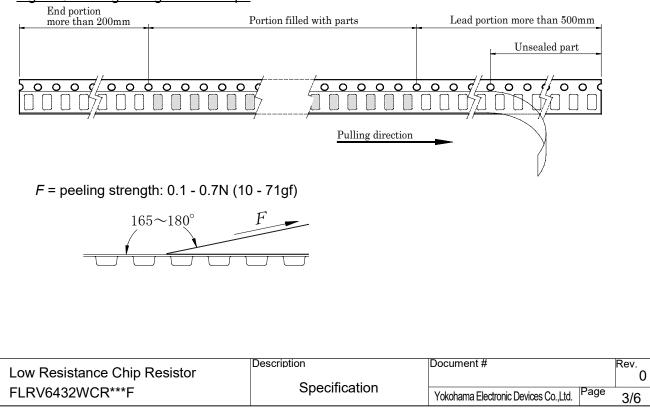
#### Figure-2 Plastic Tape····Taping form

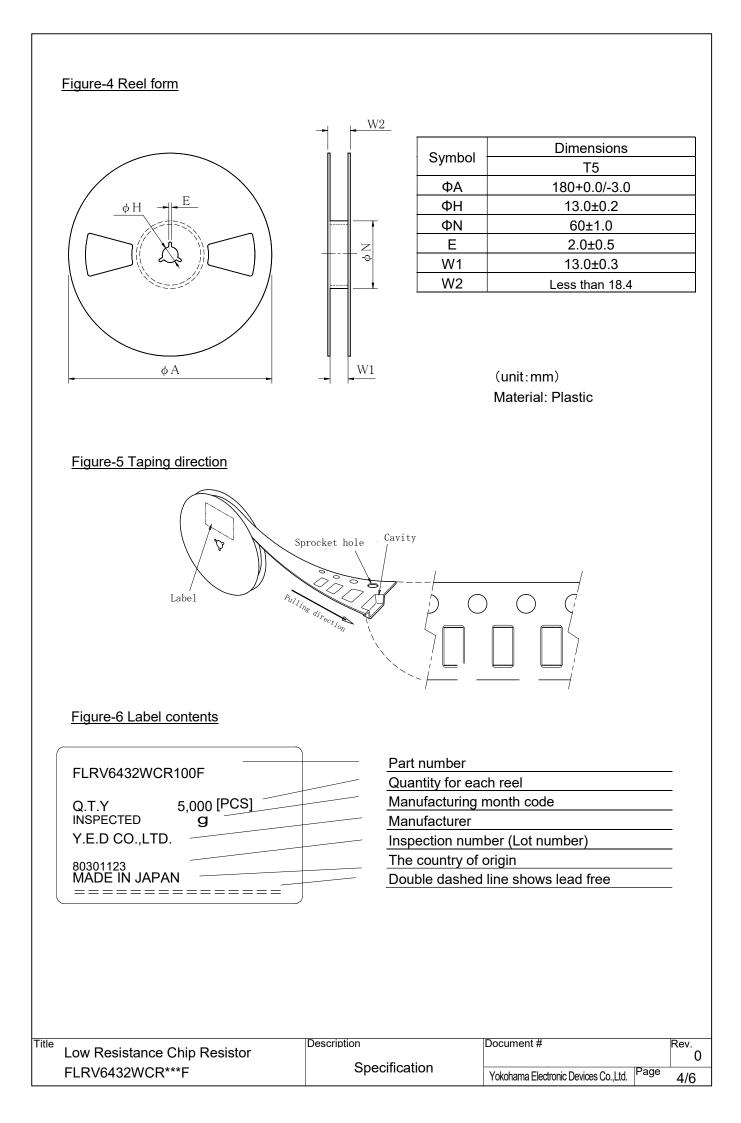


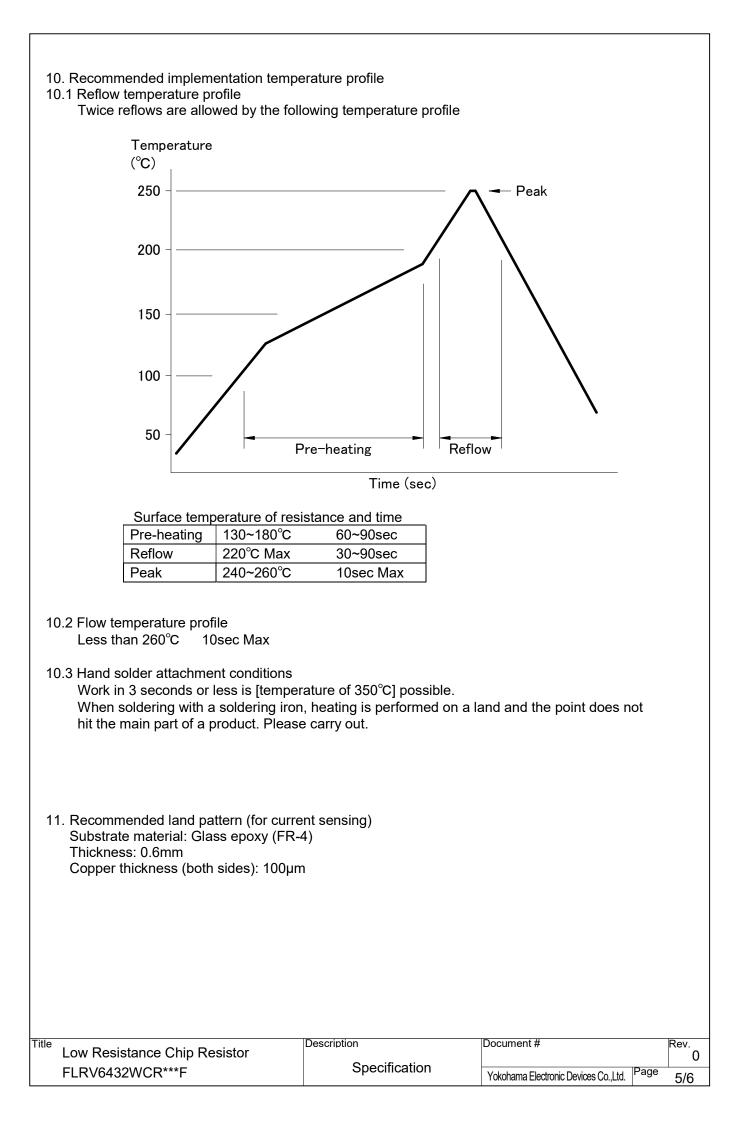
Symbol	Dimensions (mm)
A <sub>0</sub>	3.43 ±0.2
B <sub>0</sub>	6.63 ±0.2
W	12.0 ±0.3
F	5.50 ±0.05
E	1.75 ±0.1
P <sub>0</sub>	4.00 ±0.1
P <sub>1</sub>	4.00 ±0.1
P <sub>2</sub>	2.00 ±0.05
D <sub>0</sub>	1.50 +0.1/-0
D <sub>1</sub>	1.50 +0.2/-0
Т	0.20 ±0.05
T <sub>2</sub>	0.76 ±0.1

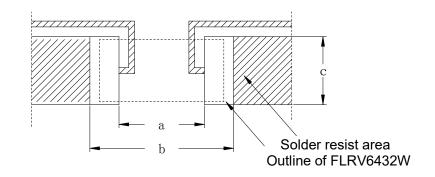
#### Figure-3 Peeling strength of seal tape

Title









	Dimensions (mm)		
Resistance	а	b	с
~4mΩ	1.20	7.40	3.50
5 to 8mΩ	2.50	7.40	3.50
9mΩ~	4.40	7.40	3.50

#### 12. Storage note

- (1) To maintain good solderability, Store the components in the temperature and humidity controlled room. Temperature: 5~35°C Humidity: 45~85% RH
- (2) Store the components at the place avoiding moisture, dust and corrosive harmful gas (hydrogen chloride, sulfurous acid gas and hydrogen sulfide) that may cause the decrease in solderability.
- (3) Store the components at the place avoiding direct sunlight.